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| SERIAL NUMBER 10/667,391 | FILING DATE 09/23/2003 RULE | CLASS 438 | GROUP ART UNIT 2812 | ATTORNEY DOCKET NO. M4065.0222/P222-B |
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APPLICANTS

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** CONTINUING DATA *****
 This application is a DIV of 09/680,473 10/06/2000 PAT 6,647,620 *SPB*
 which is a DIV of 09/469,630 12/22/1999 PAT 6,413,102

** FOREIGN APPLICATIONS *****
NONE *SPB*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED
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|---|------------------------------|------------------------|-----------------------|----------------------------|
| Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no | STATE OR COUNTRY ID | SHEETS DRAWING 8 | TOTAL CLAIMS 24 | INDEPENDENT CLAIMS 4 |
| 35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance <i>SPB</i> | Verified and Acknowledged | Examiner's Signature | Initials | |

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TITLE
 Method of making a center bond flip chip semiconductor carrier

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